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Enhanced surface transfer doping of diamond by V₂O₅ with improved thermal stability

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Surface transfer doping of hydrogen-terminated diamond has been achieved utilising V₂O₅ as a surface electron accepting material. Contact between the oxide and diamond surface promotes the transfer of electrons from the diamond into the V₂O₅ as revealed by the synchrotron-based high resolution photoemission spectroscopy. Electrical characterization by Hall measurement performed before and after V₂O₅ deposition shows an increase in hole carrier concentration in the diamond from 3.0×10^{12} to $1.8 \times 10^{13} \text{ cm}^{-2}$ at room temperature. High temperature Hall measurements performed up to 300 °C in atmosphere reveal greatly enhanced thermal stability of the hole channel produced using V₂O₅ in comparison with an air-induced surface conduction channel. Transfer doping of hydrogen-terminated diamond using high electron affinity oxides such as V₂O₅ is a promising approach for achieving thermally stable, high performance diamond based devices in comparison with air-induced surface transfer doping. © 2016 AIP Publishing LLC.

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Diamond has a wide electronic band-gap of 5.47 eV, combined with an intrinsically high breakdown field of 10 MV/cm, an exceptional thermal conductivity of >20 W/cm K, and a hole saturation velocity of $0.85\text{--}1.2 \times 10^7 \text{ cm s}^{-1}$, which makes it very attractive for high frequency, high power applications based on devices such as field effect transistors (FETs).¹ The robust nature of diamond may enable devices which operate beyond the capabilities of conventional solid-state devices in terms of power handling capacity and operating environment. However, conventional substitutional doping in diamond remains challenging which has limited its potential exploitation for electronic applications.² Alternatively, surface transfer doping of hydrogen-terminated diamond (H-diamond) shows great promise. This doping process traditionally relies upon interfacial electron transfer between the diamond valence band and favourable energy states provided by atmospheric molecules dissolved in a water layer naturally adsorbed on the diamond surface.³ High frequency devices based on H-diamond exposed to air have already been demonstrated with the fabrication of FETs^{4,5} showing a cut-off frequency (f_T) of up to 53 GHz⁶ and a maximum frequency (f_{max}) of 120 GHz.⁷ However, the stability of this atmospheric layer upon which the transfer doping process relies has been a significant limiting factor in the production of high-power handling and robust operation devices, with a maximum high power operation of 2 W/mm at 1 GHz reported thus far.⁸

In recent studies, substitution of the surface atmospheric layer with solid-state surface acceptors for efficient surface transfer doping of H-diamond has been actively pursued.² The fullerene molecule C₆₀⁹ and its fluorinated variants C₆₀F₄₈¹⁰ and F₄-TCNQ¹¹ are well known to have a high electron affinity (EA) and have been demonstrated to induce surface transfer doping on H-diamond. These organic materials, however, still demonstrate limited stability in air, despite attempts to encapsulate them.¹² A more recent approach has demonstrated improved stability up to 550 °C in air¹³ through atomic layer deposition (ALD) of Al₂O₃ on H-diamond, resulting in carrier concentrations between 8.0×10^{12} and $1.5 \times 10^{13} \text{ cm}^{-2}$. Recently, 1 kV operation of FETs has also been demonstrated using this Al₂O₃ passivation technique.¹⁴ Similarly, Al₂O₃ has been used to encapsulate previously identified NO₂ surface acceptor states,¹⁵ achieving higher temperature operation.¹⁶ Although this work has yielded very promising device performance, the exact mechanism that is responsible for the hole accumulation of diamond passivated by Al₂O₃ is still a point of investigation. Similar work involving ALD deposition of Al₂O₃ and HfO₂ has been explored for use in H-diamond MOSFETs.¹⁷

Previous work has demonstrated the transition metal oxide MoO₃ to be a promising candidate for surface transfer doping of H-diamond,^{18,19} showing a significant increase in carrier concentration and improvement in temperature stability over atmospheric transfer doping. In this study, we present V₂O₅ as an alternative transition metal oxide for the surface transfer doping of H-diamond. In comparison with

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MoO₃, V₂O₅ also possesses a sufficiently high electron affinity (EA \sim 6.3 eV,²⁰) to potentially induce surface transfer doping in H-diamond (Figure 1). Indeed, both MoO₃ and V₂O₅ have recently been shown to also induce transfer doping in thin film graphene structures.²⁰ Both the doping efficiency and the stability in air of V₂O₅ outperform that of MoO₃,^{20–22} suggesting that V₂O₅ may provide a more attractive transfer doping solution for application in diamond FET technology.

The experimental work in this study was carried out in two stages using (i) 4.7 mm² boron doped single crystal diamond¹⁹ grown via chemical vapour deposition (CVD) on a type IIa (001) CVD sample (Element Six) and (ii) two intrinsic single crystal CVD diamonds²³ grown on Ib HPHT diamond substrates: stage 1—Photoemission spectroscopy (PES) of the H-diamond/V₂O₅ interface and stage 2—Electrical characterisation of the subsurface hole channel in the diamond formed by V₂O₅ and air-induced surface transfer doping.

In Stage 1, for enabling PES studies of the interfacial electronic structures, a 300 nm-thick boron-doped epitaxial layer with a boron concentration in the order of 10¹⁸ cm⁻³ was grown by microwave plasma assisted CVD on one of the diamond substrates used for this study. Details on the epitaxial growth of the boron-doped adlayer can be found in Ref. 19. Prior to PES measurements, the diamond sample was cleaned thoroughly by boiling in an acid mixture (H₂SO₄:HNO₃:HClO₄ = 1:1:1) to remove any metallic and organic adsorbates. Hydrogen-termination was then achieved using a dedicated microwave hydrogen plasma reactor with the diamond substrate kept at around 800 °C to produce a hydrogen-terminated 2 × 1 reconstructed surface. All subsequent preparations and PES measurements were performed in an ultra-high vacuum (UHV) chamber with a base pressure of 1 × 10⁻¹⁰ mbar fitted at the end-station of SINS beamline at the Singapore Synchrotron Light Source (SSLS).²⁴ The sample was annealed *in-situ* at 400 °C for about 10 min to remove any residual surface adsorbates and/or remnant hydrocarbon molecules from the hydrogen

plasma process, whilst leaving the hydrogen termination intact.^{25,26} After cooling-down to room temperature, the deposition of V₂O₅ was carried out by subliming from a standard Knudsen-cell set at 590 °C. The nominal thickness of V₂O₅ thin films was estimated from the attenuation of the bulk diamond C 1s peak intensity after each deposition.

PES spectra of the C 1s and V 2p were recorded by a Scienta R4000 electron energy analyzer at normal emission geometry using photon energies of 350 eV and 650 eV, respectively. The binding energies of all PES spectra were calibrated and referenced to the Fermi energy of a sputtered gold foil in electrical contact with the diamond sample. The work function was measured by recording the secondary electron emission in the low kinetic energy region with an incoming photon energy set to 60 eV. A -9 V bias was applied to the sample in order to overcome the work function of the analyzer.

The diamond surface band bending, which can be revealed by the rigid shifts in diamond C 1s component, is a direct signature of hole accumulation in diamond induced by surface transfer doping.^{9,11} The evolution of diamond C 1s PES spectra, as a function of V₂O₅ coverage, is shown in Figure 2(a). Immediately after the deposition of 0.4 Å V₂O₅, a rigid shift of 0.30 eV of the diamond C1s peak to the lower binding energy side is clearly observed, consistent with an upward band bending expected after electron transfer from the diamond valence band to surface acceptors. The diamond peak continues to shift to the lower binding energy side with subsequent V₂O₅ deposition and becomes almost unchanged with V₂O₅ coverage beyond 18 Å as also shown in Figure 2(d). The total binding energy shift as a result of V₂O₅ deposition is 0.95 ± 0.05 eV, suggesting a further upward band bending of the same amount towards the diamond surface (Figure 1(b)). The band bending amount, and thus the areal hole concentration on the diamond surface, is comparable with that for MoO₃ doped diamond surface,¹⁹ suggesting that V₂O₅ is at least as effective in surface transfer doping of diamond as MoO₃.

On the V₂O₅ side, negatively charged V₂O₅ interfacial clusters are identified in the V 2p spectra by performing least square peak fitting routine to deconvolute the V⁴⁺ species (Figure 2(b)).²⁷ The V⁴⁺/V⁵⁺ ratio is found to be reduced significantly from 0.27 for 0.8 Å V₂O to less than 0.08 for 6.4 Å and eventually becomes 0 within the instrumental detection limit for thickness beyond 51 Å. This thickness dependent V⁴⁺/V⁵⁺ intensity ratio corroborates the interfacial nature of the negatively charged V₂O₅ species as expected from the surface transfer doping model^{10,11} and clearly rules out the possibility of the formation of reduced V₂O₅ species due to oxygen vacancies during the deposition process. Finally, the work function, as indicated by the secondary electron cut-off (SECO) in Figure 2(c) (also see Figure 2(e)), increases from 3.80 eV for clean H-diamond to 6.90 eV for bulk V₂O₅, as a result of the interface dipole built from the interfacial charge separation.

In Stage 2, unlike the diamond sample used for PES analysis which utilised a boron doped surface layer to eliminate charging effects, intrinsic diamond samples sourced without any additional doping were used for this electrical characterisation study. Details on the epitaxial growth of the intrinsic layer are reported in Ref. 23. Prior to hydrogen termination, two nominally identical samples were cleaned in

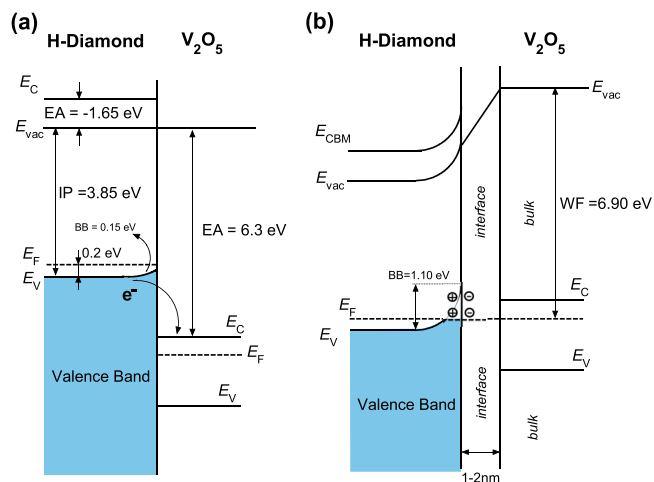


FIG. 1. Schematic energy level diagram before and after surface transfer doping using V₂O₅ as a surface acceptor. Other than the electron affinity (EA) of V₂O₅, all energy levels are determined by PES following established procedures.¹¹ IP represents ionization potential. EA represents electron affinity and BB represents band bending. The uncertainty of the position of the energy level is 0.10 eV.

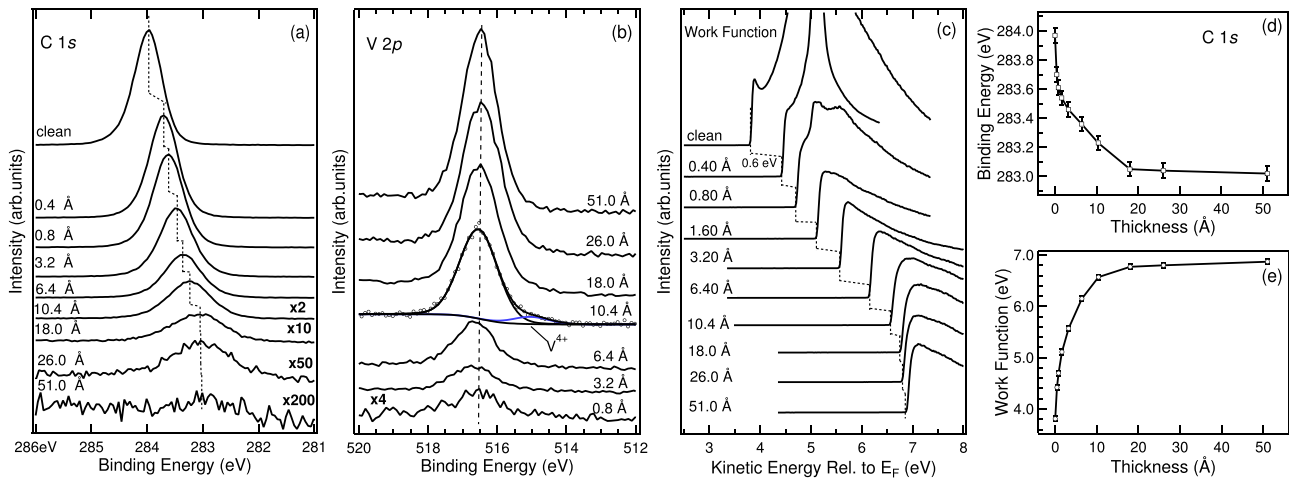


FIG. 2. PES core level spectra of (a) C 1s with photon energy of 350 eV, (b) V $2p_{3/2}$ with photon energy of 650 eV, and (c) secondary electron cut-off indicating work function using photon energy of 60 eV for hydrogen-terminated diamond with increasing V_2O_5 thickness. The diamond C 1s peak position and work function as a function of V_2O_5 thickness are plotted in (d) and (e), respectively. An example of the least square peak fitting (blue line) for the V $2p_{3/2}$ peaks is shown for 10.4 Å of V_2O_5 .

$HNO_3:HCl$ followed by $H_2SO_4:HNO_3$ to remove any metallic and organic adsorbents. These were then treated with hydrogen plasma for 30 min at a substrate temperature of 600 °C to terminate the surface with hydrogen. Van der Pauw (VDP) test structures were fabricated on each by applying silver paste to the corners of the samples. For the purpose of making “large area” ohmic contacts to H-diamond for our VDP structures, silver contacts show a sufficiently low resistance and linear response.²⁸ Use of this simplified VDP structure minimises the risk of incurring contamination of the diamond surface using standard processing techniques, e.g., exposure to resists, chemicals, and electron beam. One sample was then baked at 400 °C for 1 h *in situ* to remove any atmospheric molecules from the H-diamond surface before 100 nm of V_2O_5 was thermally evaporated without exposing the sample to atmosphere post *in situ* anneal. This annealing stage is required to ensure that any observable transfer doping is induced by the V_2O_5 only and is not attributed to any residual encapsulated atmospheric species on the H-diamond surface.

Hall measurements were taken for this sample in an air environment before and after encapsulation with V_2O_5 using a Nanometrics HL5500 Hall measurement system. This yielded values for the sheet resistance, hole mobility, and carrier concentration, when the H-diamond surface was initially exposed to air and then encapsulated with V_2O_5 (Table I).

Due to the dependence on the variable and largely uncontrollable atmospheric surface layer for surface transfer doping in air-exposed H-diamond, reported electrical properties for the resultant hole conducting channel vary substantially.²⁹ Typical values for areal hole density have been found to vary between 10^{12} and 10^{13} cm^{-2} at room

temperature for polycrystalline and single crystal CVD films alike. Mobility has also been shown to vary with values of 30–120 $\text{cm}^2/\text{V s}$ typical. In this experiment, the results show that utilising V_2O_5 as a surface acceptor material generated a six fold increase in carrier concentration with a final value of $1.8 \times 10^{13} \text{ cm}^{-2}$ in comparison to the air induced value of $3 \times 10^{12} \text{ cm}^{-2}$. Subsequently, sheet resistance was almost halved and mobility fell from 118 to 37 $\text{cm}^2/\text{V s}$. The final value of carrier concentration seen here is very close to that we reported elsewhere for MoO_3 surface transfer doping, which has a similar value of EA.¹⁹ Further optimisation of the processing conditions for these oxide:H-diamond systems, such as hydrogen termination, surface roughness, and oxide growth, may yield higher carrier densities within the diamond and hence requires further investigation. The mechanism by which mobility is reduced is not well understood at present, though is often correlated with higher carrier concentration, possibly due to increased coulomb scattering at the interface.³⁰ Similar reduction in mobility was also observed after increased carrier concentration induced by MoO_3 .^{18,19}

To verify the high resistivity of standalone V_2O_5 films, 100 nm of V_2O_5 was deposited simultaneously onto an insulating SiN substrate and electrically characterised. This demonstrated no measurable current through the oxide above the noise floor of the measurement system ($\sim 100 \text{ nA}$).

Further Hall measurements were performed between room temperature and 300 °C in atmosphere on the V_2O_5 encapsulated sample and on the second VDP test sample that remained unencapsulated with its surface exposed to air. These results which are plotted in Figure 3 show the hole density of the V_2O_5 doped sample to be largely stable up to ~ 250 °C with a gradual increase in sheet resistance at higher temperatures as carrier concentration begins to decrease above 250 °C. Mobility is observed to vary marginally for this sample but generally decreases slowly with increased temperature. These results are in sharp contrast to those attained for the air-doped sample, which exhibits a rapid increase in sheet resistance above ~ 60 °C due to a combined reduction of both carrier concentration and mobility. The

TABLE I. Electrical transport characteristics of diamond before and after V_2O_5 deposition.

	Sheet resistance ($k\Omega/\square$)	Mobility ($\text{cm}^2/\text{V s}$)	Sheet carrier concentration (cm^{-2})
Air induced doping	17.8	118.0	3.0×10^{12}
After V_2O_5 deposition	9.5	37.2	1.8×10^{13}

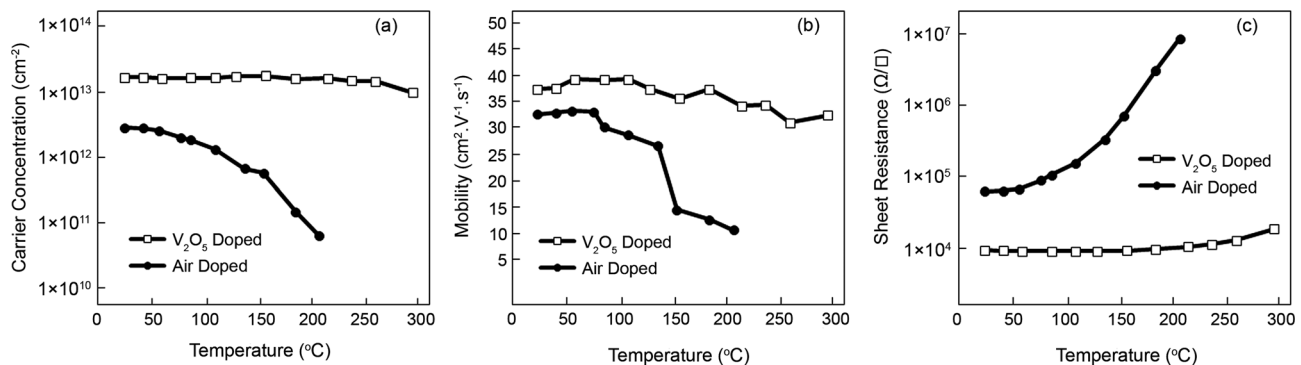


FIG. 3. Hall measurements for both V₂O₅ and air doped H-terminated diamond plotted against temperature: (a) carrier concentration, (b) mobility, and (c) sheet resistance.

observed decrease in carrier concentration for this sample is readily explained by desorption of the airborne molecular species from the air-exposed H-diamond surface with increased temperature.³ The exact mechanism by which the mobility is reduced with increased temperature for the air-doped sample is more difficult to explain but may be related to reduced screening of interface scattering effects as the carrier density is reduced. Unfortunately, no Hall data are available for the air-doped sample above ~200 °C as its electrical properties were degraded to the point that it became unmeasurable by our measurement system.

In conclusion, the transition metal oxide V₂O₅ has been demonstrated to induce surface transfer doping on hydrogen-terminated diamond as verified by both photoemission spectroscopy and Hall measurement. These results show excellent potential in comparison with air-induced transfer doping, with good stability when exposed to atmosphere at elevated temperatures up to ~250 °C. While the composition of atmospheric molecules on the surface is volatile and uncontrollable, surface transfer doping utilising oxide-based surface acceptors represent a viable solid-state approach to enable diamond-based surface conducting electronics. Furthermore, while the band bending in diamond and total work function shift are comparable to those of MoO₃, V₂O₅ may prove to be a more stable and hence desirable solution for implementation in surface-transfer doped diamond electronic devices. Further investigation into the stability of these materials and their potential integration into diamond field-effect transistors is therefore warranted.

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